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Silicon NPN Triple Diffused

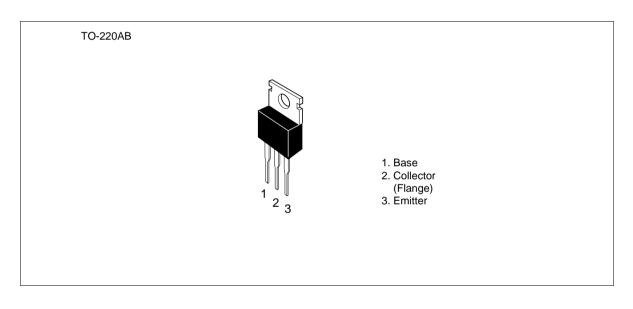


ADE-208-909 (Z) 1st. Edition September 2000

### **Application**

TV horizontal deflection output

#### **Outline**



## **Absolute Maximum Ratings** (Ta = 25°C)

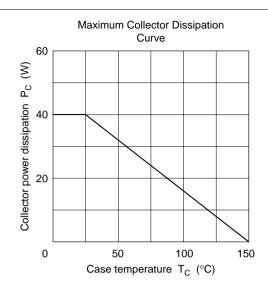
		Rating			
Item	Symbol	2SD1163	2SD1163A	Unit	
Collector to base voltage	$V_{\text{CBO}}$	300	350	V	
Collector to emitter voltage	V <sub>CEO</sub>	120	150	V	
Emitter to base voltage	$V_{EBO}$	6	6	V	
Collector current	I <sub>c</sub>	7	7	А	
Collector peak current	I <sub>C (peak)</sub>	10	10	А	
Collector surge current	I <sub>C (surge)</sub>	20	20	А	
Collector power dissipation	P <sub>c</sub> *1	40	40	W	
Junction temperature	Tj	150	150	°C	
Storage temperature	Tstg	-55 to +150	-55 to +150	°C	

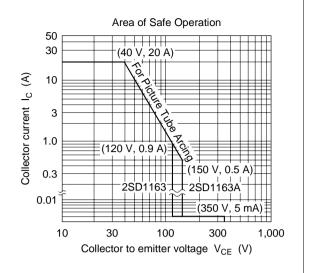
Note: 1. Value at  $T_c = 25^{\circ}C$ .

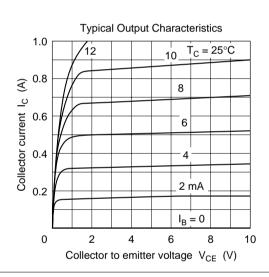
## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

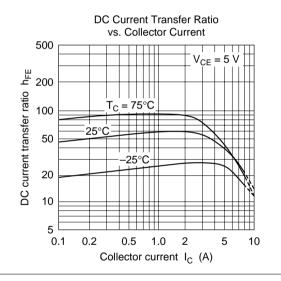
		2SD1	163		2SD1163A				
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector cutoff current	I <sub>CBO</sub>	_	_	5	_	_	_	mA	$V_{CB} = 300 \text{ V}, I_{E} = 0$
		_	_	_	_	_	5	mΑ	$V_{CB} = 350 \text{ V}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	_	_	150	_	_	V	$I_{\rm C}$ = 10 mA, $R_{\rm BE}$ = $\infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	6	_	_	6	_	_	V	$I_{E} = 10 \text{ mA}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub>	25	_	_	25	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ A}^{*1}$
Collector to emitter saturation voltage	V <sub>CE (sat)</sub>	_	_	2.0	_	_	1.0	V	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 0.5 \text{ A}^{*1}$
Base to emitter saturation voltage	V <sub>BE (sat)</sub>	_	_	1.2	_		1.2	V	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 0.5 \text{ A}^{*1}$
Fall time	t <sub>f</sub>	_	_	0.5	_	_	0.5	μs	$I_{CP} = 3.5 \text{ A},$ $I_{B1} = 0.45 \text{ A}$

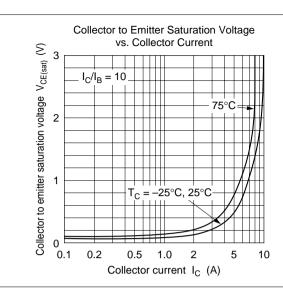
Note: 1. Pulse test.

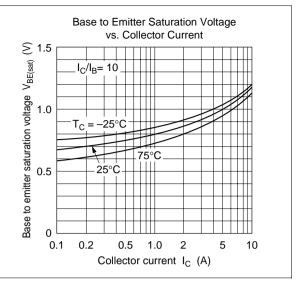












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